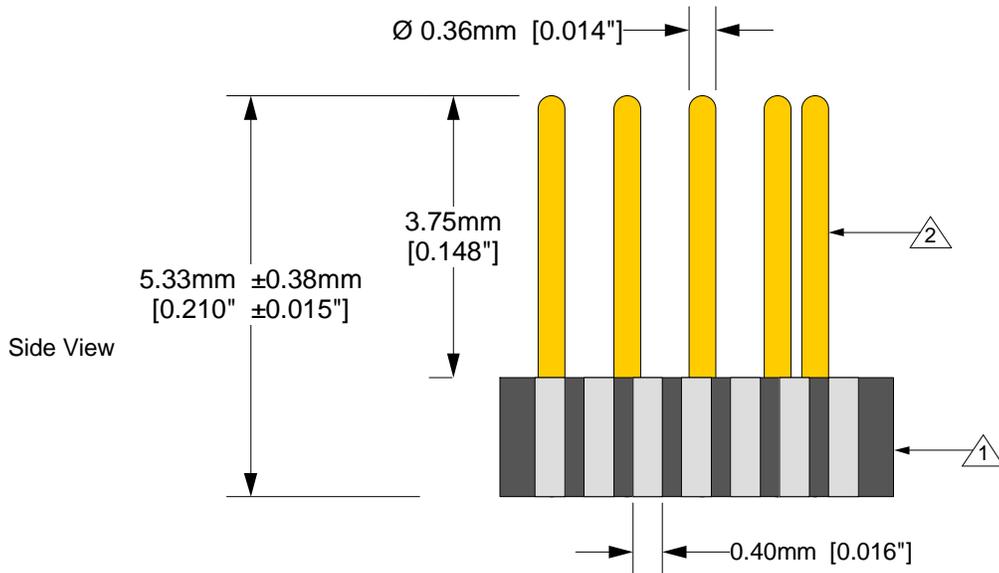
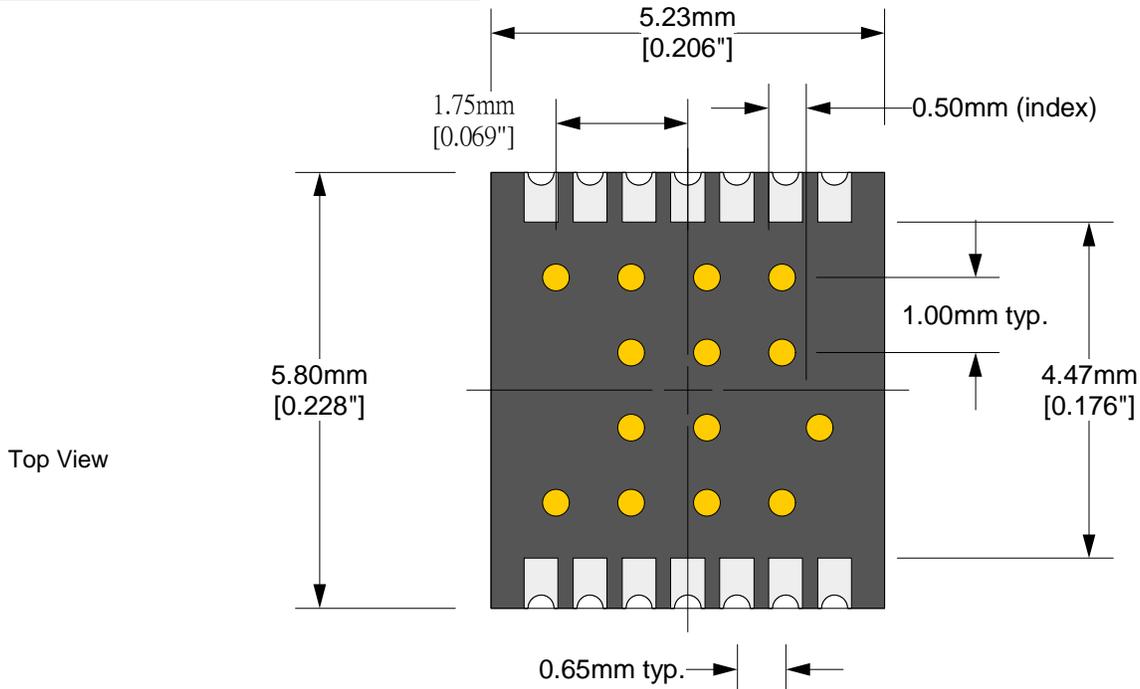


RoHS COMPLIANT



1 Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] per IPC 4101/21, RoHS compliant plating.

2 Pins: material- Brass Alloy 360 1/2 hard; finish- 0.25µm [10µ"] Au over 1.27µm [50µ"] Ni (min.).

Description: Surface Mount Emulator Foot (SF), TSSOP
14 position leadless surface mountable emulator foot with micro grid array (UGA) pin interface.

Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.13mm [±0.005"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SF-SO14G-L-01F Drawing		Status: Released	Scale: 10:1	Rev: A
 <p>© 2006 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337 Tele: (952) 229-8200 www.ironwoodelectronics.com</p>	Drawing by: E Smolentseva		Date: 07/25/06	
	File: SF-SO14G-L-01F Dwg		Modified:	